

1. General description

Passivated, sensitive gate thyristors in a plastic envelope, intended for use in general purpose switching and phase control applications. These devices are intended to be interfaced directly to microcontrollers, logic integrated circuits and other low power gate trigger circuits.

2. Features and benefits

- Sensitive gate
- Planar passivated for voltage ruggedness and reliability
- Direct triggering from low power drivers and logic ICs
- Surface mountable package

3. Applications

- · General purpose switching and phase control
- Ignition circuits, CDI for 2- and 3-wheelers
- Motor control e.g. small kitchen appliances

4. Quick reference data

Table 1. Quick reference data

Symbol	Parameter	Conditions		Min	Тур	Max	Unit
V _{RRM}	repetitive peak reverse voltage			-	-	600	V
I _{T(AV)}	average on-state current	half sine wave; T _{mb} ≤ 111 °C; <u>Fig. 1</u>		-	-	5	A
I _{T(RMS)}	RMS on-state current	half sine wave; T _{mb} ≤ 111 °C; <u>Fig. 2;</u> <u>Fig. 3</u>		-	-	8	A
I _{TSM}	non-repetitive peak on- state current	half sine wave; T _{j(init)} = 25 °C; t _p = 10 ms; <u>Fig. 4; Fig. 5</u>		-	-	75	A
		half sine wave; T _{j(init)} = 25 °C; t _p = 8.3 ms		-	-	82	A
Tj	junction temperature		[1]	-	-	125	°C
Static character	eristics						2
I _{GT}	gate trigger current	V _D = 12 V; I _T = 0.1 A; T _j = 25 °C; <u>Fig. 7</u>		-	50	200	μA
Dynamic chara	ateristics						-
dV _D /dt	rate of rise of off-state voltage	V_{DM} = 402 V; T _j = 125 °C; R _{GK} = 100 Ω; (V_{DM} = 67% of V_{DRM}); exponential waveform; Fig. 12		50	100	-	V/µs

[1] Operation above 110° C may require the use of a gate to cathode resistor of $1k\Omega$ or less.

5. Pinning information

Pin	Symbol	Description	Simplified outline	Graphic symbol
1	К	cathode	mb	А- DI К
2	А	anode		Ġ sym037
3	G	gate		Symost
mb	A	mounting base; connected to anode	1 2 3 IPAK (TO-251)	

6. Ordering information

Table 3. Ordering information						
Type number	Package					
	Name	Description	Version			
BT258U-600R	IPAK	plastic single-ended package (IPAK); 3 leads (in-line)	TO-251			

Logic level thyristor

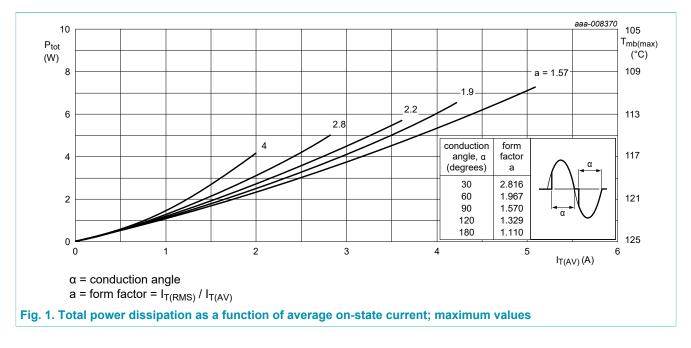
7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134).

Symbol	Parameter	Conditions	Min	Max	Unit
V _{DRM}	repetitive peak off-state voltage		-	600	V
V _{RRM}	repetitive peak reverse voltage		-	600	V
I _{T(AV)}	average on-state current	half sine wave; T _{mb} ≤ 111 °C; <u>Fig. 1</u>	-	5	А
I _{T(RMS)}	RMS on-state current	half sine wave; T _{mb} ≤ 111 °C; <u>Fig. 2;</u> <u>Fig. 3</u>	-	8	A
I _{TSM}	non-repetitive peak on- state current	half sine wave; T _{j(init)} = 25 °C; t _p = 10 ms; Fig. 4; Fig. 5	-	75	A
		half sine wave; T _{j(init)} = 25 °C; t _p = 8.3 ms	-	82	А
l ² t	I ² t for fusing	t _p = 10 ms; SIN	-	28	A²s
dl _T /dt	rate of rise of on-state current	I _G = 1 mA	-	50	A/µs
I _{GM}	peak gate current		-	2	А
V _{RGM}	peak reverse gate voltage		-	5	V
P _{GM}	peak gate power		-	5	W
P _{G(AV)}	average gate power	over any 20 ms period	-	0.5	W
T _{stg}	storage temperature		-40	150	°C
Tj	junction temperature		[1] -	125	°C

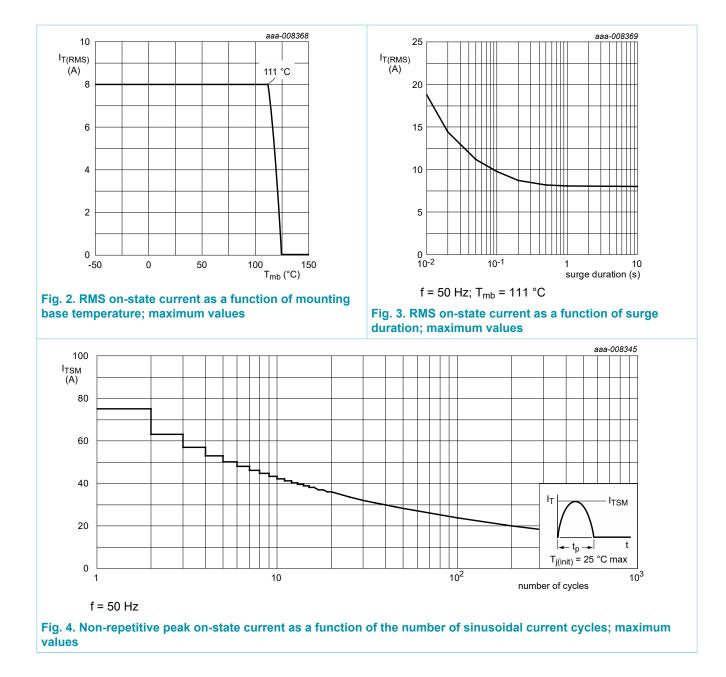
[1] Operation above 110° C may require the use of a gate to cathode resistor of $1k\Omega$ or less.



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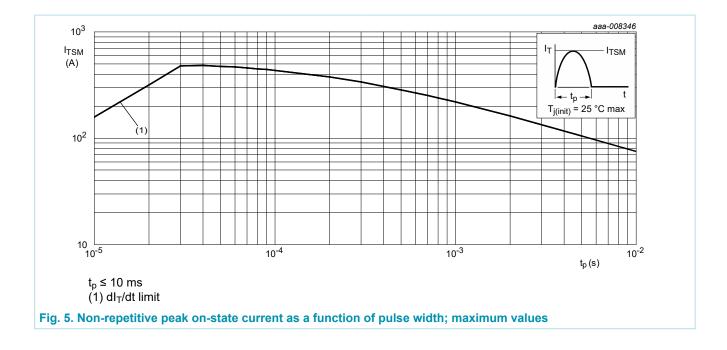
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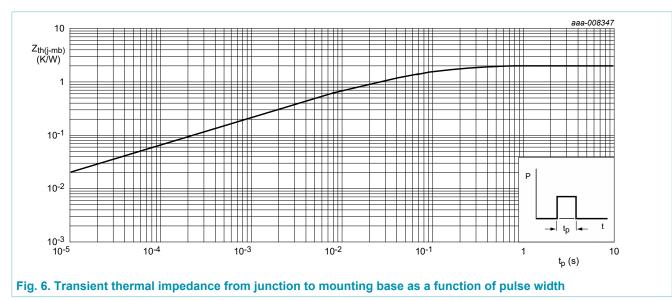
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8. Thermal characteristics

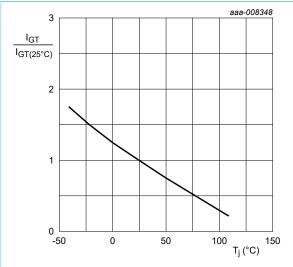
Symbol	Parameter	Conditions	Min	Тур	Max	Unit
R _{th(j-mb)}	thermal resistance from junction to mounting base	<u>Fig. 6</u>	-	-	2	K/W
R _{th(j-a)}	thermal resistance from junction to ambient free air	in free air	-	70	-	K/W



Logic level thyristor

9. Characteristics

Symbol	Parameter	Conditions	Min	Typ	Max	Unit
Symbol	Falameter	Conditions	IVIIII	Тур	IVIAX	Unit
Static chara	acteristics					
I _{GT}	gate trigger current	V_D = 12 V; I _T = 0.1 A; T _j = 25 °C; <u>Fig. 7</u>	-	50	200	μA
IL	latching current	V_D = 12 V; I_G = 0.1 A; T_j = 25 °C; <u>Fig. 8</u>	-	0.4	10	mA
I _H	holding current	V _D = 12 V; T _j = 25 °C; <u>Fig. 9</u>	-	0.3	6	mA
V _T	on-state voltage	I _T = 16 A; T _j = 25 °C; <u>Fig. 10</u>	-	1.3	1.6	V
V _{GT}	gate trigger voltage	V _D = 12 V; I _T = 0.1 A; T _j = 25 °C; Fig. 11	-	0.4	1	V
		V _D = 600 V; I _T = 0.1 A; T _j = 110 °C; <u>Fig. 11</u>	0.1	0.2	-	V
I _D	off-state current	V _D = 600 V; T _j = 125 °C	-	0.1	0.5	mA
I _R	reverse current	V _R = 600 V; T _j = 125 °C	-	0.1	0.5	mA
Dynamic ch	arateristics	· · · · · · · · · · · · · · · · · · ·	· · ·	·		
dV _D /dt	rate of rise of off-state voltage	V_{DM} = 402 V; T _j = 125 °C; R _{GK} = 100 Ω; (V_{DM} = 67% of V_{DRM}); exponential waveform; Fig. 12	50	100	-	V/µs
t _{gt}	gate-controlled turn-on time	I_{TM} = 10 A; V _D = 600 V; I _G = 5 mA; dI _G / dt = 0.2 A/µs; T _j = 25 °C	-	2	-	μs
t _q	commutated turn-off time	$V_{DM} = 402 \text{ V}; \text{ T}_{j} = 125 \text{ °C}; \text{ I}_{TM} = 12 \text{ A};$ $V_{R} = 24 \text{ V}; (dI_{T}/dt)_{M} = 10 \text{ A}/\mu\text{s}; dV_{D}/$ $dt = 2 \text{ V}/\mu\text{s}; \text{ R}_{GK(ext)} = 1 \text{ k}\Omega; (V_{DM} = 67\% \text{ of } V_{DRM})$	-	100	-	μs





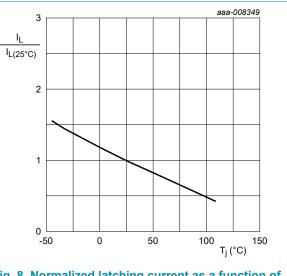
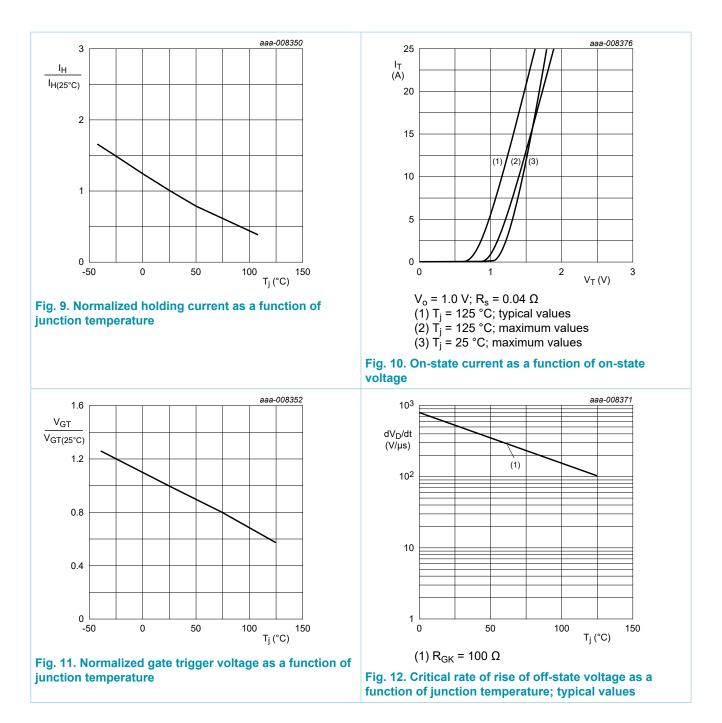


Fig. 8. Normalized latching current as a function of junction temperature

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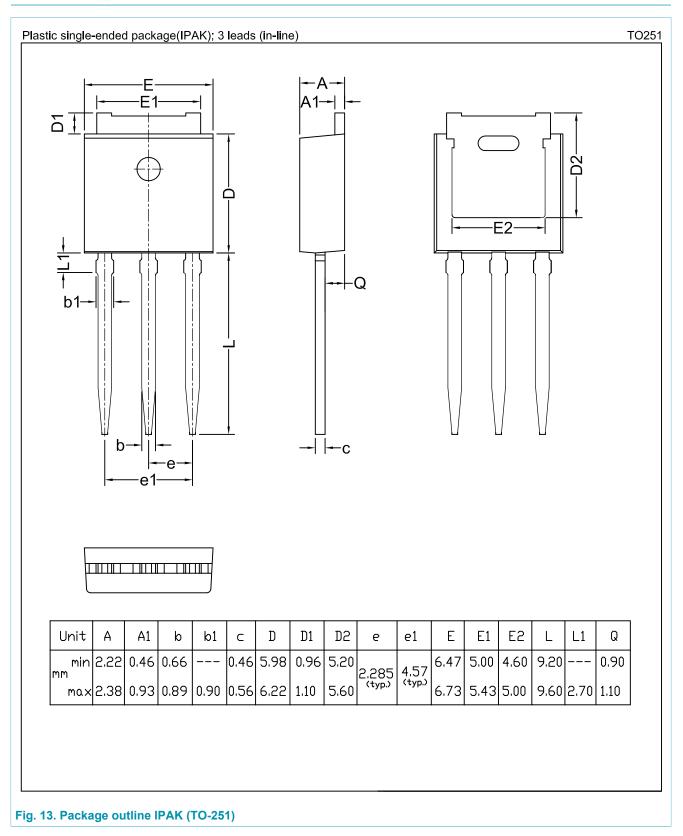
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10. Package outline



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11. Legal information

Data sheet status

Document status [1][2]	Product status [<u>3]</u>	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

[1] Please consult the most recently issued document before initiating or completing a design.

- [2] The term 'short data sheet' is explained in section "Definitions".
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